

Customer No.: 31561
Application No.: 10/604,692
Docket No.: 10156-US-PA

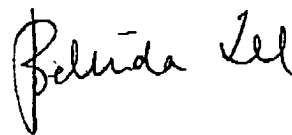
REMARKS

Applicant would like to elect Group I, claims 1-12 and 35-37, drawn to a subcombination semiconductor device and use of the semiconductor device, classified in class 257, subclass 365. Please cancel Group II, claims 13-34 and 38-45, drawn to a combination memory array and use of the memory array, classified in class 257, subclass 390 without waiver, prejudice or disclaimer.

If the Examiner believes that a telephone conference would expedite the examination of the above-identified patent application, the Examiner is invited to call the undersigned.

Date: Nov. 9, 2004

Respectfully submitted,



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